NSR20F30NXT5G

Schottky Barrier Diode

These Schottky barrier diodes are optimized for low forward voltage drop and low leakage current and are offered in a Chip Scale Package (CSP) to reduce board space. The low thermal resistance enables designers to meet the challenging task of achieving higher efficiency and meeting reduced space requirements.



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Features

• Very Low Forward Voltage Drop – 480 mV @ 2.总特基势垒二极管

^L肖特基势垒二极管针对低止 芯片级提供压降和低泄漏电流

30 V SCHOTTKY BARRIER DIODE

• Low Reverse Current – 20 μA @ 10 V VR

封装 (CSP) 以减少电路板空间 。低热阻

• 2.0 A of Continuous Forward Current ● Power Dissipation of 665 mW with Minimum Træ设计师能够完成更高的挑战性任务。

• ESD Rating – Human Body Model: Class 3B

高效并满足减少的空间要求。

1

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- Machine Model: Class C

Very High Switching Speed

• These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- LCD and Keypad Backlighting
- Camera Photo Flash
- Buck and Boost dc-dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

Markets

- Mobile Handsets
- MP3 Players
- Digital Camera and Camcorders
- Notebook PCs & PDAs
- GPS

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	30	V
Forward Current (DC)	I _F	2.0	Α
Forward Surge Current (60 Hz @ 1	cycle)	28	Α
Repetitive Peak Forward Current (Pulse Wave = 1 sec, Duty Cycle = 6	I _{FRM} 66%)	4.0	Α
ESD Rating: Human Body M Machine Model	odel ESD	> 8 > 400	kV V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



(0603)CASE 152AB

MARKING DIAGRAM



20F30 = Specific Device Code

= Year Code

ORDERING INFORMATION

Device	Package	Shipping†
NSR20F30NXT5G	DSN2 (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NSR20F30NXT5G

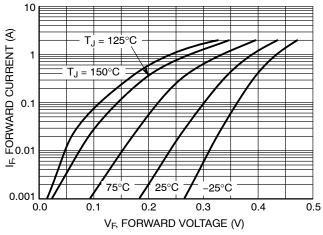
THERMAL CHARACTERISTICS

Characteristic	Symbol	Min	Тур	Max	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T _A = 25°C	R _{θJA} P _D			213 586	°C/W mW
Thermal Resistance Junction-to-Ambient (Note 2) Total Power Dissipation @ T _A = 25°C	R _{0JA} P _D			80 1.56	°C/W W
Storage Temperature Range	T _{stg}			-40 to +125	°C
Junction Temperature	TJ			+150	°C

- 1. Mounted onto a 4 in square FR-4 board 50 mm sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.
- 2. Mounted onto a 4 in square FR-4 board 1 in sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage (V _R = 10 V) (V _R = 30 V)	I _R			20 150	μΑ
Forward Voltage (I _F = 1.0 A) (I _F = 2.0 A)	V _F			0.42 0.48	V



100000 150°C 10000 IR, REVERSE CURRENT (μA) 125°C 1000 75°C 100 10 25°C 0.1 -25°C 0.01 0.001 25 30 V_R, REVERSE VOLTAGE (V)

Figure 1. Forward Voltage

Figure 2. Typical Reverse Current

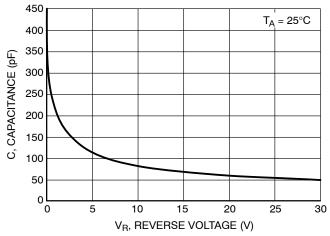
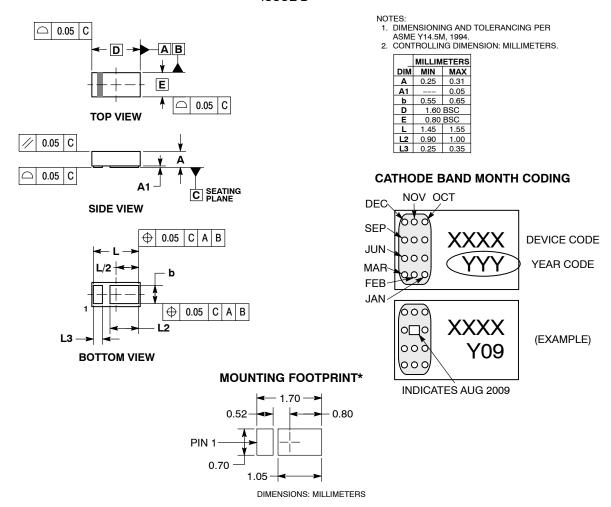


Figure 3. Typical Capacitance

NSR20F30NXT5G

PACKAGE DIMENSIONS

DSN2, 1.6x0.8, 0.9P, (0603) CASE 152AB **ISSUE B**



See Application Note AND8464/D for more mounting details

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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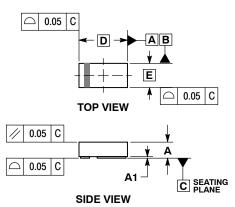
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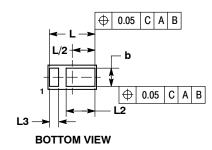
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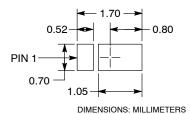
DSN2, 1.6x0.8, 0.9P, (0603) CASE 152AB ISSUE C

DATE 30 APR 2017





MOUNTING FOOTPRINT*



See Application Note AND8464/D for more mounting details

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS			
DIM	MIN	MAX		
Α	0.25	0.31		
A1		0.05		
b	0.55	0.65		
D	1.60 BSC			
E	0.80 BSC			
L	1.45	1.55		
L2	0.90	1.00		
13	0.25	0.35		

GENERIC MARKING DIAGRAM1*



XXXX = Specific Device Code YYY = Year Code

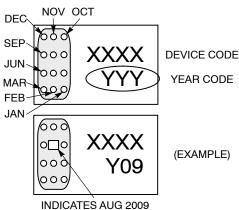
GENERIC MARKING DIAGRAM2*



XX = Specific Device Code M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present. Some products may not follow the Generic Marking

CATHODE BAND MONTH CODING



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^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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